



STS5NF60L

N - CHANNEL 60V - 0.045Ω - 5A SO-8 STripFET™ POWER MOSFET

PRELIMINARY DATA

| TYPE | V _{DSS} | R _{DS(on)} | I _D |
|-----------|------------------|---------------------|----------------|
| STS5NF60L | 60 V | < 0.055 Ω | 5 A |

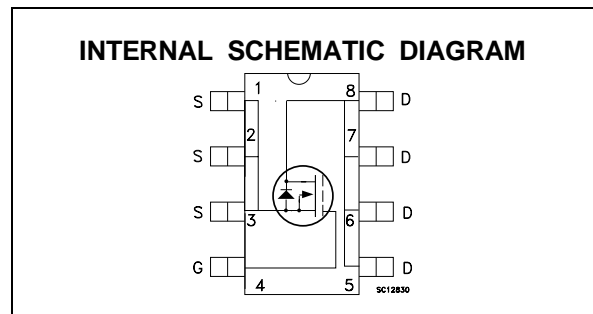
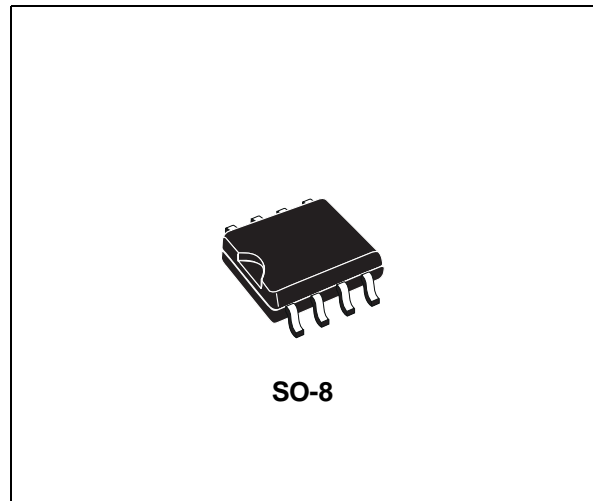
- TYPICAL R_{DS(on)} = 0.045 Ω
- STANDARD OUTLINE FOR EASY AUTOMATED SURFACE MOUNT ASSEMBLY
- LOW THRESHOLD DRIVE

DESCRIPTION

This Power MOSFET is the second generation of STMicroelectronics unique " Single Feature Size™ " strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

APPLICATIONS

- DC MOTOR DRIVE
- DC-DC CONVERTERS
- BATTERY MANAGEMENT IN NOMADIC EQUIPMENT
- POWER MANAGEMENT IN PORTABLE/DESKTOP PC_s



ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|---------------------|---|-------|------|
| V _{DS} | Drain-source Voltage (V _{GS} = 0) | 60 | V |
| V _{DGR} | Drain- gate Voltage (R _{GS} = 20 kΩ) | 60 | V |
| V _{GS} | Gate-source Voltage | ± 20 | V |
| I _D | Drain Current (continuous) at T _c = 25 °C | 5 | A |
| | Drain Current (continuous) at T _c = 100 °C | 3 | A |
| I _{DM} (•) | Drain Current (pulsed) | 20 | A |
| P _{tot} | Total Dissipation at T _c = 25 °C | 2.5 | W |

(•) Pulse width limited by safe operating area

STS5NF60L

THERMAL DATA

| | | | |
|--|---|-------------------------|------------------|
| R _{thj-amb} T _j T _{stg} | (*)Thermal Resistance Junction-ambient Maximum Operating Junction Temperature Storage Temperature | 50 150 -55 to 150 | °C/W °C °C |
|--|---|-------------------------|------------------|

(*) Mounted on FR-4 board (t ≤ 10sec)

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

OFF

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|----------------------|---|--|------|------|---------|----------|
| V _{(BR)DSS} | Drain-source Breakdown Voltage | I _D = 250 μA V _{GS} = 0 | 60 | | | V |
| I _{DSS} | Zero Gate Voltage Drain Current (V _{GS} = 0) | V _{DS} = Max Rating V _{DS} = Max Rating T _c = 125 °C | | | 1 10 | μA μA |
| I _{GSS} | Gate-body Leakage Current (V _{DS} = 0) | V _{GS} = ± 20 V | | | ± 100 | nA |

ON (*)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------------|-----------------------------------|---|------|---------------|----------------|--------|
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} = V _{GS} I _D = 250 μA | 1 | 1.7 | 2.5 | V |
| R _{DS(on)} | Static Drain-source On Resistance | V _{GS} = 10 V I _D = 2.5 A V _{GS} = 4.5 V I _D = 2.5 A | | 0.045 0.05 | 0.055 0.065 | Ω Ω |
| I _{D(on)} | On State Drain Current | V _{DS} > I _{D(on)} × R _{DS(on)max} V _{GS} = 10 V | 5 | | | A |

DYNAMIC

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--|---|--|------|-------------------|------|----------------|
| g _{fs} (*) | Forward Transconductance | V _{DS} > I _{D(on)} × R _{DS(on)max} I _D = 2.5 A | | 7 | | S |
| C _{iss} C _{oss} C _{rss} | Input Capacitance Output Capacitance Reverse Transfer Capacitance | V _{DS} = 25 V f = 1 MHz V _{GS} = 0 V | | 1250 130 26 | | pF pF pF |

ELECTRICAL CHARACTERISTICS (continued)

SWITCHING ON

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|-------------|--------------------|---|------|------|------|------|
| $t_{d(on)}$ | Turn-on Time | $V_{DD} = 15\text{ V}$ $I_D = 2.5\text{ A}$ | | TBD | TBD | ns |
| t_r | Rise Time | $R_G = 4.7\ \Omega$ $V_{GS} = 4.5\text{ V}$ | | | | ns |
| Q_g | Total Gate Charge | $V_{DD} = 48\text{ V}$ $I_D = 5\text{ A}$ $V_{GS} = 4.5\text{ V}$ | | | 25 | nC |
| Q_{gs} | Gate-Source Charge | | | | | nC |
| Q_{gd} | Gate-Drain Charge | | | | | nC |

SWITCHING OFF

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------|-----------------------|---|------|------|------|------|
| $t_{r(Voff)}$ | Off-voltage Rise Time | $V_{DD} = 48\text{ V}$ $I_D = 5\text{ A}$ | | TBD | TBD | ns |
| t_f | Fall Time | $R_G = 4.7\ \Omega$ $V_{GS} = 4.5\text{ V}$ | | | | ns |
| t_c | Cross-over Time | | | | | ns |

SOURCE DRAIN DIODE

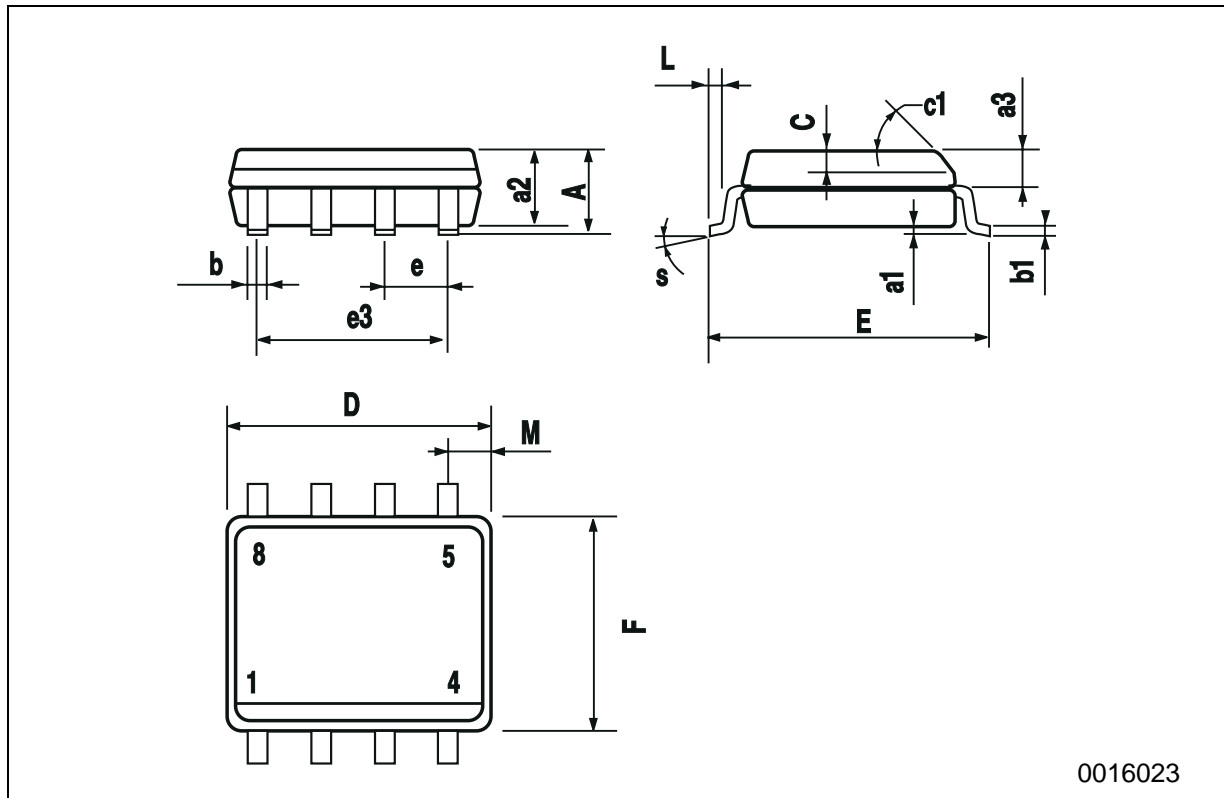
| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--------------------|-------------------------------|---|------|------|------|------|
| I_{SD} | Source-drain Current | | | | 5 | A |
| $I_{SDM}(\bullet)$ | Source-drain Current (pulsed) | | | | 20 | A |
| $V_{SD}(\ast)$ | Forward On Voltage | $I_{SD} = 5\text{ A}$ $V_{GS} = 0$ | | | 1.2 | V |
| t_{rr} | Reverse Recovery Time | $I_{SD} = 5\text{ A}$ $di/dt = 100\text{ A}/\mu\text{s}$ $V_r = 20\text{ V}$ $T_j = 150\text{ }^\circ\text{C}$ | | TBD | | ns |
| Q_{rr} | Reverse Recovery Charge | | | | | nC |
| I_{RRM} | Reverse Recovery Current | | | | | A |

(*) Pulsed: Pulse duration = 300 μs , duty cycle 1.5 %

(•) Pulse width limited by safe operating area

SO-8 MECHANICAL DATA

| DIM. | mm | | | inch | | |
|------|-----------|------|------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | | | 1.75 | | | 0.068 |
| a1 | 0.1 | | 0.25 | 0.003 | | 0.009 |
| a2 | | | 1.65 | | | 0.064 |
| a3 | 0.65 | | 0.85 | 0.025 | | 0.033 |
| b | 0.35 | | 0.48 | 0.013 | | 0.018 |
| b1 | 0.19 | | 0.25 | 0.007 | | 0.010 |
| C | 0.25 | | 0.5 | 0.010 | | 0.019 |
| c1 | 45 (typ.) | | | | | |
| D | 4.8 | | 5.0 | 0.188 | | 0.196 |
| E | 5.8 | | 6.2 | 0.228 | | 0.244 |
| e | | 1.27 | | | 0.050 | |
| e3 | | 3.81 | | | 0.150 | |
| F | 3.8 | | 4.0 | 0.14 | | 0.157 |
| L | 0.4 | | 1.27 | 0.015 | | 0.050 |
| M | | | 0.6 | | | 0.023 |
| S | 8 (max.) | | | | | |



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